

## 30V N-Channel Enhancement Mode MOSFET

**Description**

The PECN3400BVR uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and high density cell Design for ultra low on-resistance. This device is suitable for use as a load switch or in PWM applications.

**General Features**

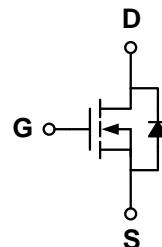
- ◆  $V_{DS} = 30V$ ,  $I_D = 5A$   
 $R_{DS(ON)}(\text{Typ.}) = 43m\Omega$  @  $V_{GS} = 2.5V$   
 $R_{DS(ON)}(\text{Typ.}) = 31m\Omega$  @  $V_{GS} = 4.5V$
- ◆ High power and current handing capability
- ◆ Lead free product is acquired
- ◆ Surface mount package

**Application**

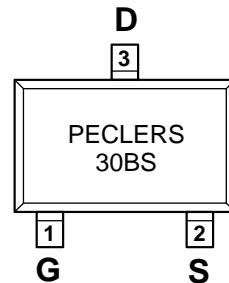
- ◆ PWM applications
- ◆ Load switch

**Package**

- ◆ SOT-23

**Schematic diagram****Marking and pin assignment**

SOT-23  
(TOP VIEW)

**Ordering Information**

Part Number	Storage Temperature	Package	Devices Per Reel
PECN3400BVR	-55°C to +150°C	SOT-23	3000

**Absolute Maximum Ratings (TA=25°C unless otherwise noted)**

parameter	symbol	limit	unit
Drain-source voltage	$V_{DS}$	30	V
Gate-source voltage	$V_{GS}$	$\pm 12$	V
Drain current-continuous <sup>a</sup> @Tj=125°C -pulse d <sup>b</sup>	$I_D$	5	A
	$I_{DM}$	30	A
Drain-source Diode forward current	$I_S$	2	A
Maximum power dissipation	$P_D$	1.4	W
Operating junction Temperature range	Tj	-55—150	°C

**Electrical Characteristics** (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>OFF Characteristics</b>						
Drain-source breakdown voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	30	-	-	V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V	-	-	1	μA
Gate-body leakage	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±12V	-	-	±100	nA
<b>ON Characteristics</b>						
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	0.7	0.9	1.4	V
Drain-source on-state resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =5A V <sub>GS</sub> =2.5V, I <sub>D</sub> =4A	-	31	45	mΩ
Forward transconductance	g <sub>f</sub>	V <sub>GS</sub> =5V, I <sub>D</sub> =5A	-	43	59	
<b>Dynamic Characteristics</b>						
Input capacitance	C <sub>ISS</sub>	V <sub>DS</sub> =15V, V <sub>GS</sub> =0V f=1.0MHz	-	822	-	pF
Output capacitance	C <sub>OSS</sub>		-	98	-	
Reverse transfer capacitance	C <sub>RSS</sub>		-	76	-	
<b>Switching Characteristics</b>						
Turn-on delay time	t <sub>D(ON)</sub>	V <sub>DS</sub> =15V V <sub>GS</sub> =10V R <sub>L</sub> =2.6 ohm R <sub>GEN</sub> =3ohm	-	3.3	-	ns
Rise time	tr		-	4.8	-	
Turn-off delay time	t <sub>D(OFF)</sub>		-	25	-	
Fall time	tf		-	4	-	
Total gate charge	Q <sub>g</sub>	V <sub>DS</sub> =15V, I <sub>D</sub> =5.8A V <sub>GS</sub> =4.5V	-	9.5	-	nC
Gate-source charge	Q <sub>gs</sub>		-	1.5	-	
Gate-drain charge	Q <sub>gd</sub>		-	3	-	
<b>DRAIN-SOURCE DIODE CHARACTERISTICS</b>						
Diode forward voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>s</sub> =1A	-	0.76	1.16	V

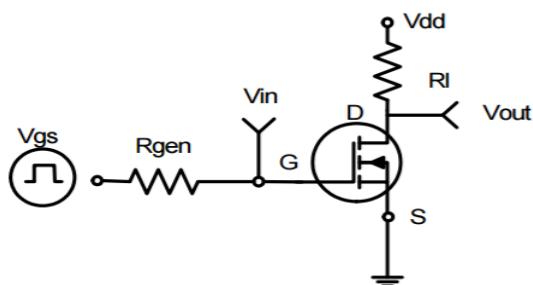
**Notes:**

- a. surface mounted on FR4 board, t≤10sec
- b. pulse test: pulse width≤300μs, duty≤2%
- c. guaranteed by design, not subject to production testing

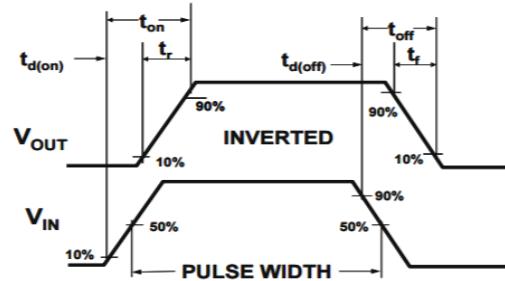
**Thermal Characteristics**

Thermal Resistance junction-to ambient	R <sub>th JA</sub>	100	°C/W
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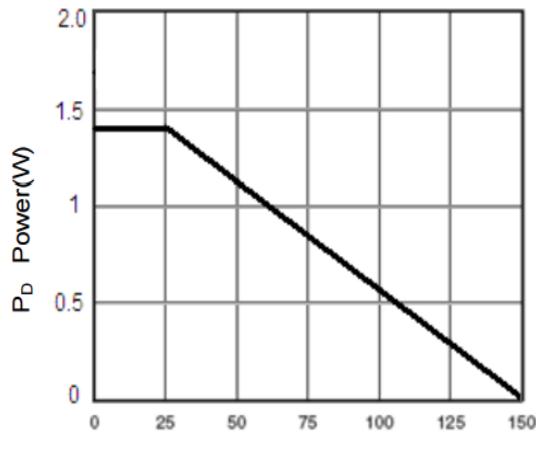
### Typical Performance Characteristics



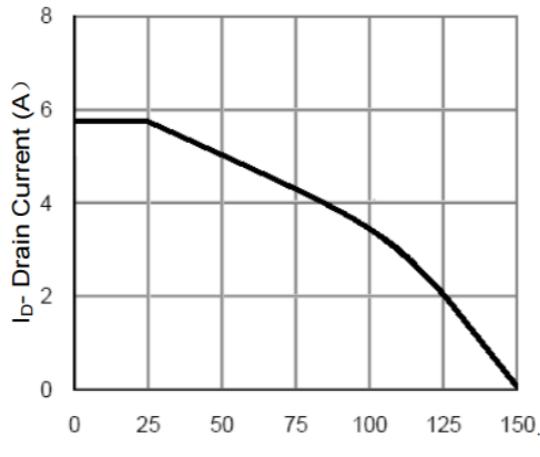
**Figure 1:Switching Test Circuit**



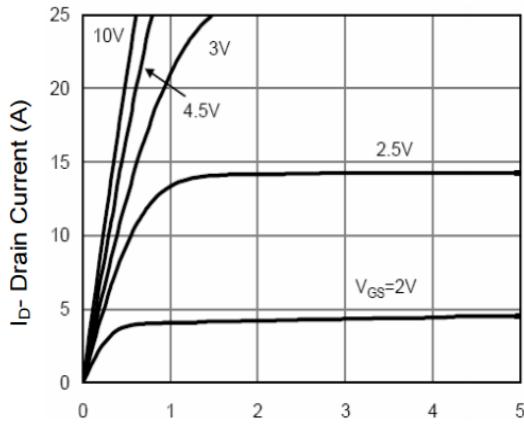
**Figure 2:Switching Waveforms**



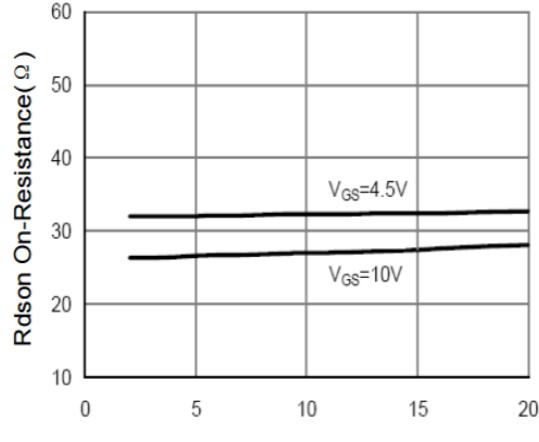
**Figure 3 Power Dissipation**



**Figure 4 Drain Current**



**Figure 5 Output Characteristics**



**Figure 6 Drain-Source On-Resistance**

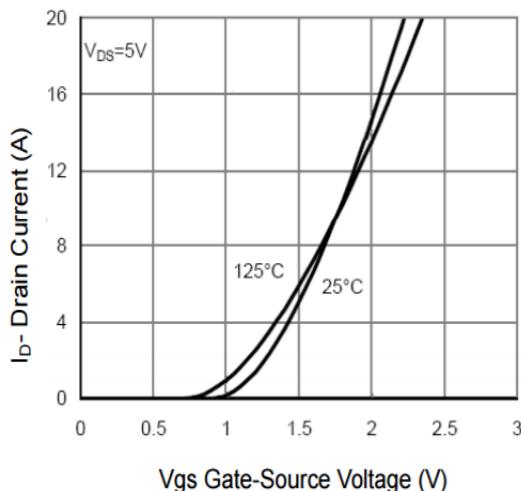


Figure 7 Transfer Characteristics

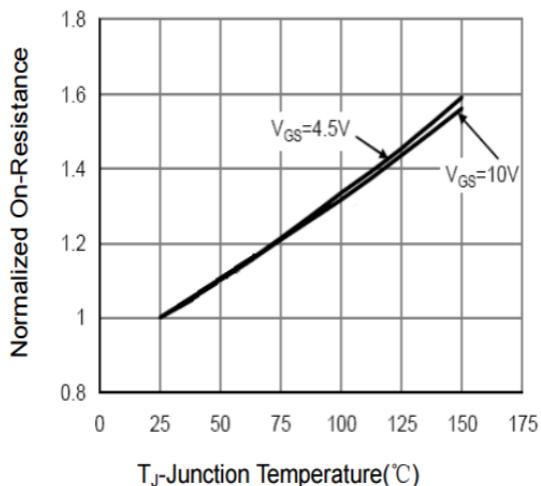


Figure 8 Drain-Source On-Resistance

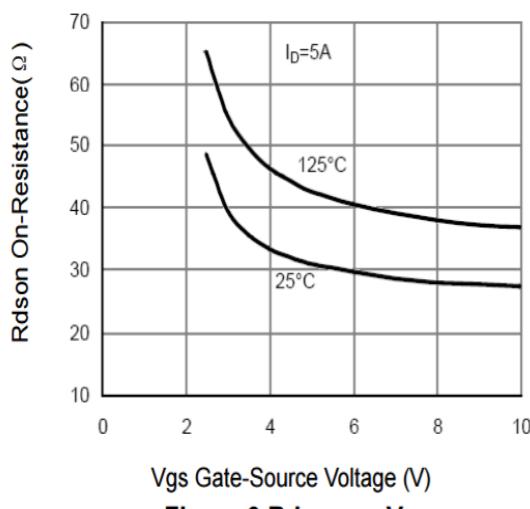


Figure 9  $R_{DS(on)}$  vs  $V_{GS}$

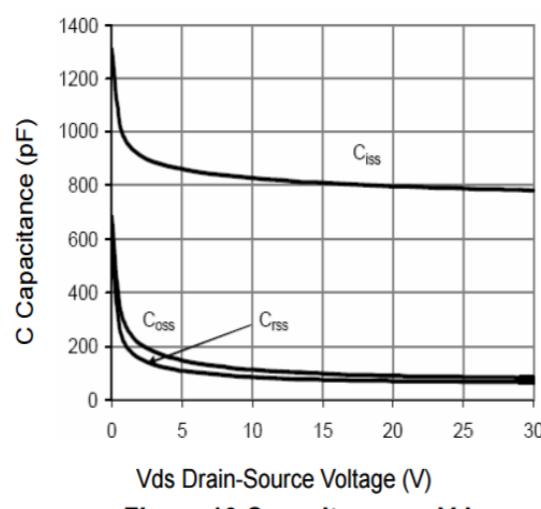


Figure 10 Capacitance vs  $V_{DS}$

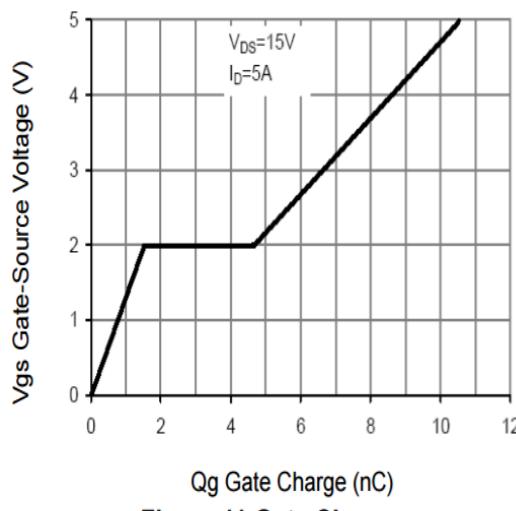


Figure 11 Gate Charge

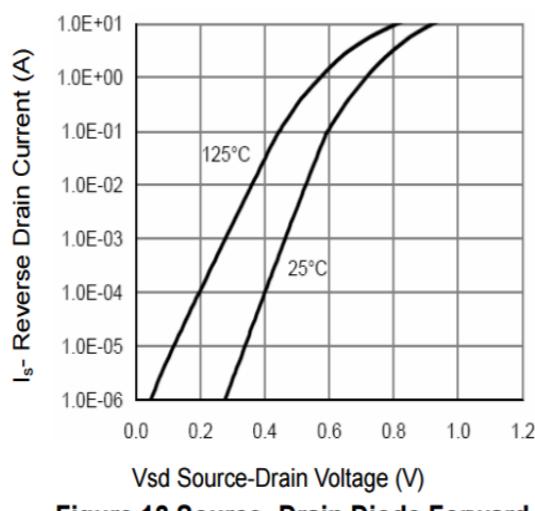
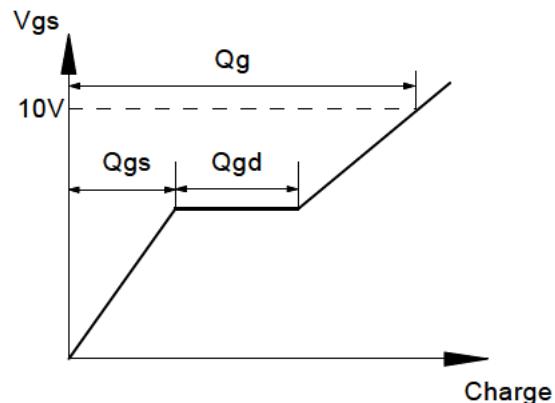
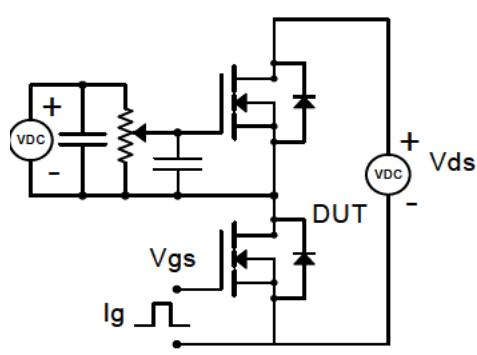


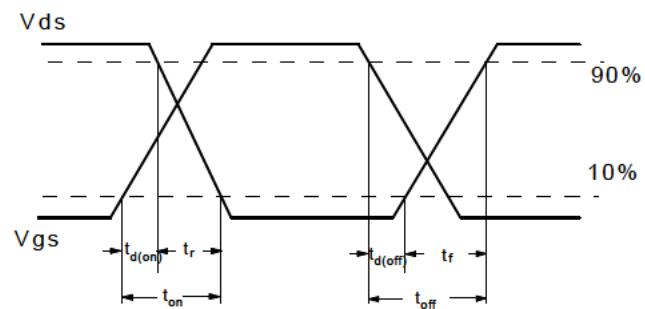
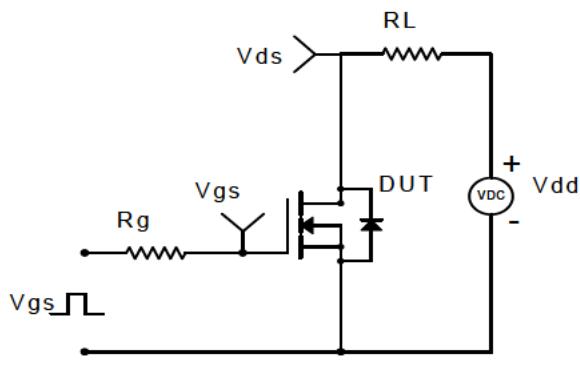
Figure 12 Source-Drain Diode Forward

Gate Charge Test Circuit & Waveform

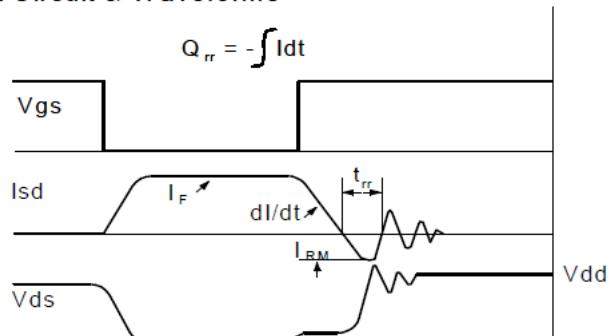
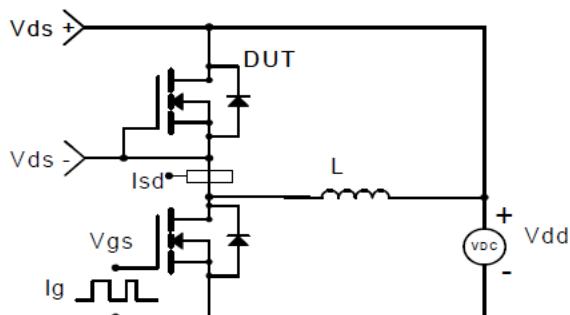


Resistive Switching Test Circuit & Waveforms

Resistive Switching Test Circuit & Waveforms

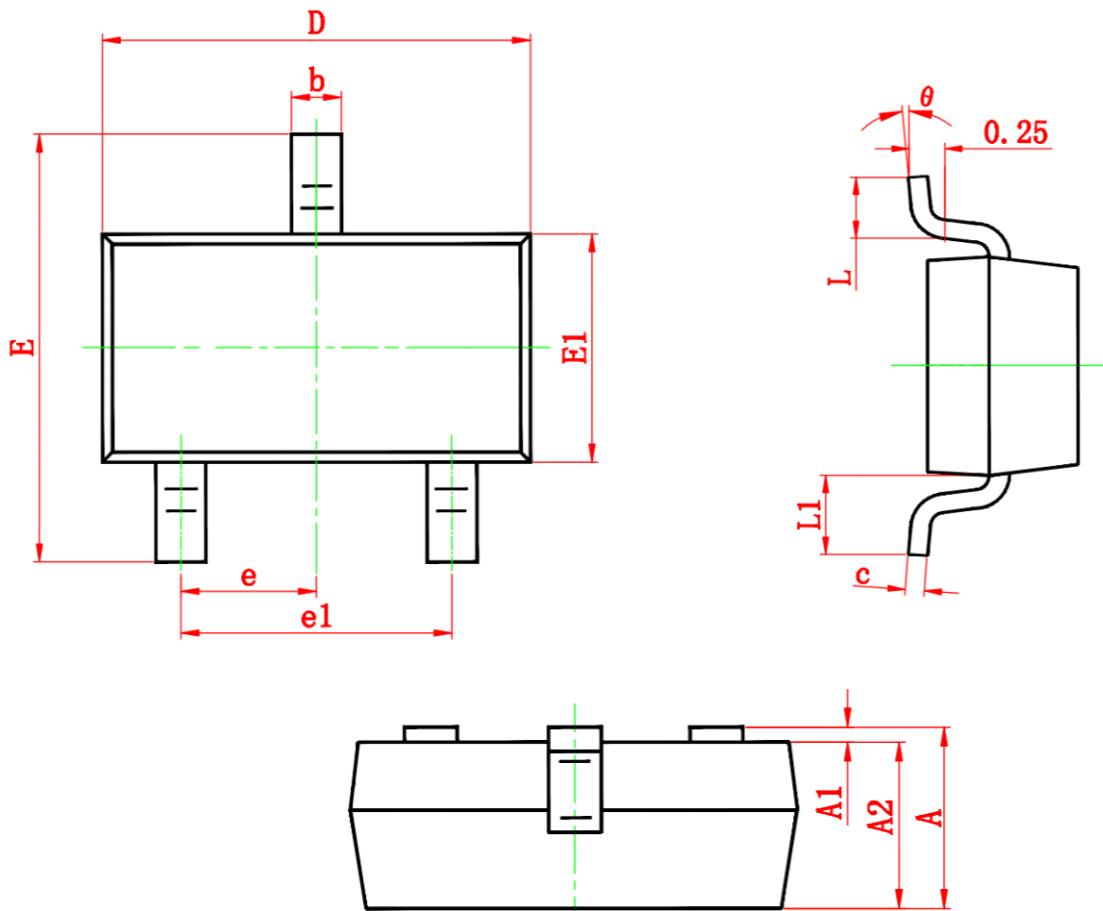


Diode Recovery Test Circuit & Waveforms



## Package Information

- SOT-23



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	2.250	2.550	0.089	0.100
E1	1.200	1.400	0.047	0.055
e	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.300	0.500	0.012	0.020
L1	0.550 REF.		0.022 REF.	
$\theta$	0°	8°	0°	8°